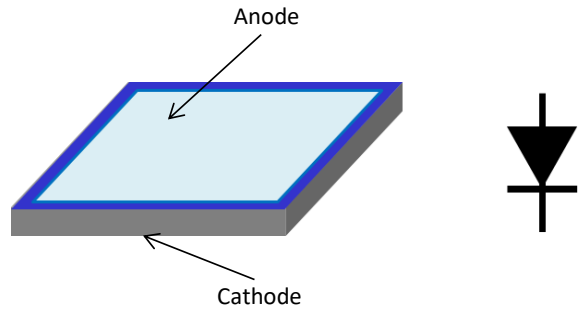


# YJ Planar Schottky Barrier Diode Die Specification

40V 3A, 50mil, Schottky barrier diode die based on silicon planar process  
Part No.: PSB050S040SS-280A

## Main Products Characteristics

- Average forward current:  $I_{F(AV)} = 3\text{ A}$
- Maximum operating junction temperature:  $T_j = 175\text{ °C}$
- ESD rating: >8KV, per IEC61000-4-2 (Contact Discharge)
- Top metal: Ag



## Maximum Ratings

Parameter	Symbol	Rating
Repetitive peak reverse voltage	$V_{RRM}$	40 V
Average forward current	$I_{F(AV)}$	3 A
Non-repetitive peak surge current ( $t_p = 8.3\text{ ms}$ , halfwave, 1 cycle)	$I_{FSM}$	80 A
Storage temperature range	$T_{stg}$	-50 to +175 °C
Maximum operating junction temperature	$T_j$	175 °C

## Static Electrical Characteristics ( $T_a = 25\text{ °C}$ )

Parameter	Symbol	Value	
		Spec	Typical
Reverse breakdown voltage $I_R = 1\text{ mA}$	$V_{BR}$	45 V	52V
Maximum forward voltage drop $I_F = 3\text{ A}$ Pulse Test: $t_p = 300\text{ }\mu\text{s}$ , $\delta \leq 2\%$	$V_F$	0.65V	0.61V
Maximum reverse current $V_R = V_{RRM}$ Pulse Test: $t_p = 300\text{ }\mu\text{s}$ , $\delta \leq 2\%$	$I_R$	5uA	1uA

## Device Schematics and Outline Drawing

The top view shows a square die with a central 'Active Area' surrounded by three concentric rings: 'First Ring', 'Second Ring', and 'Third Ring'. A 'Top Metal Pad' is located at the top. The 'Die Size' is indicated by a dashed line. The cross-section shows the 'Back Metal' at the bottom, followed by the 'Substrate', 'Guard Ring', 'Epi' layer, 'SiO2' layer, 'Schottky Barrier', and 'Top Metal' at the top.

Die Thickness *	11 Mils
Die Size **	50 Mils
Top Metal Pad	46 Mils
Active Area	42 Mils
Top Metal	Ag
Back Metal	Ag

Note: 1 \* : Also can offer device with 8 mils thickness  
2 \*\*: Cutting street width is around 1.5 mils

## Important Notice

<p>Specification apply to die only. Actual performance may degrade when assembled.</p> <p><b>Yangjie Electronics</b> does not guarantee device performance after assembly. All operating parameters must be validated for each customer application by customer's technical experts.</p> <p>Data sheet information is subjected to change without notice.</p>	<p>Recommended Storage Environment:</p> <p>Store in original container, in dessicated nitrogen, with no contamination.</p> <p>Shelf life for parts stored in above condition is 2 years.</p> <p>If the storage is done in normal atmosphere shelf life is reduced to 6 months.</p>
---	--